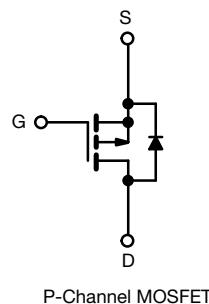
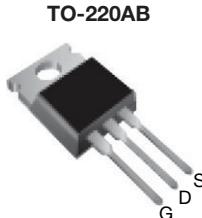


## Power MOSFET

PRODUCT SUMMARY	
$V_{DS}$ (V)	-200
$R_{DS(on)}$ max. ( $\Omega$ )	$V_{GS} = -10$ V 0.80
$Q_g$ max. (nC)	29
$Q_{gs}$ (nC)	5.4
$Q_{gd}$ (nC)	15
Configuration	Single



### FEATURES

- Dynamic dv/dt rating
- Repetitive avalanche rated
- P-channel
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS\***  
Available

### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF9630PbF SiHF9630-E3
SnPb	IRF9630 SiHF9630

ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	$V_{DS}$	-200	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current	$V_{GS}$ at -10 V	$I_D$	
		-6.5	A
Pulsed Drain Current <sup>a</sup>	$T_C = 25$ °C	-4.0	
		-26	A
Linear Derating Factor		0.59	W/°C
Single Pulse Avalanche Energy <sup>b</sup>	$E_{AS}$	500	mJ
Repetitive Avalanche Current <sup>a</sup>	$I_{AR}$	-6.4	A
Repetitive Avalanche Energy <sup>a</sup>	$E_{AR}$	7.4	mJ
Maximum Power Dissipation	$P_D$	74	W
Peak Diode Recovery dv/dt <sup>c</sup>	dv/dt	-5.0	V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +150	°C
Soldering Recommendations (Peak temperature) <sup>d</sup>	for 10 s	300	
Mounting Torque	6-32 or M3 screw	10	lbf · in
		1.1	N · m

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = -50$  V, starting  $T_J = 25$  °C,  $L = 17$  mH,  $R_g = 25$  Ω,  $I_{AS} = -6.5$  A (see fig. 12).

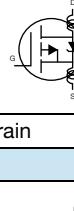
c.  $I_{SD} \leq -6.5$  A,  $dI/dt \leq 120$  A/μs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 150$  °C.

d. 1.6 mm from case.

**THERMAL RESISTANCE RATINGS**

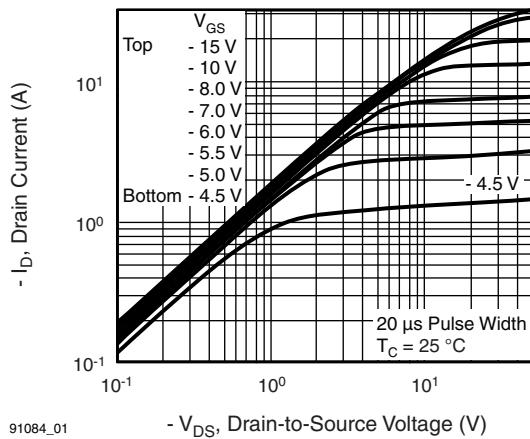
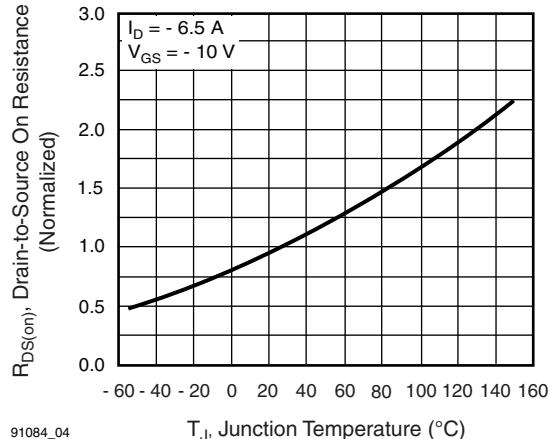
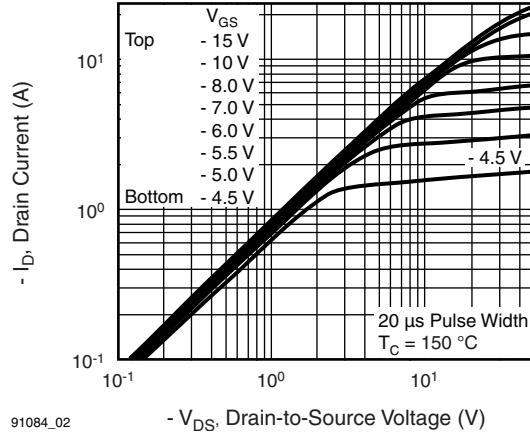
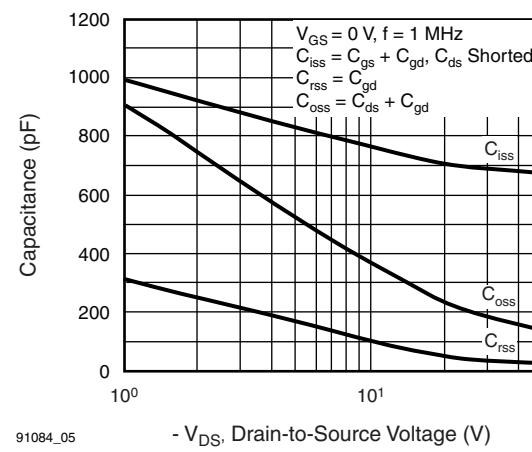
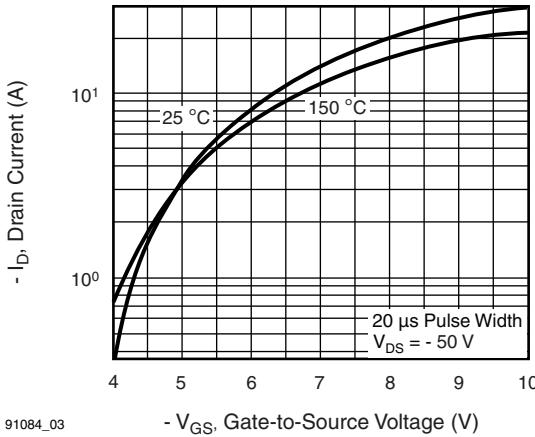
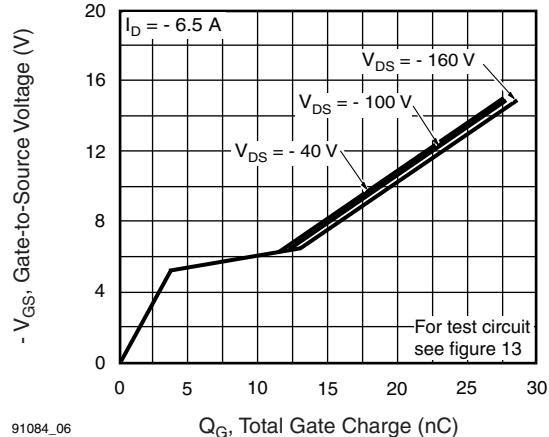
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	62	°C/W
Case-to-Sink, Flat, Greased Surface	$R_{thCS}$	0.50	-	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	1.7	

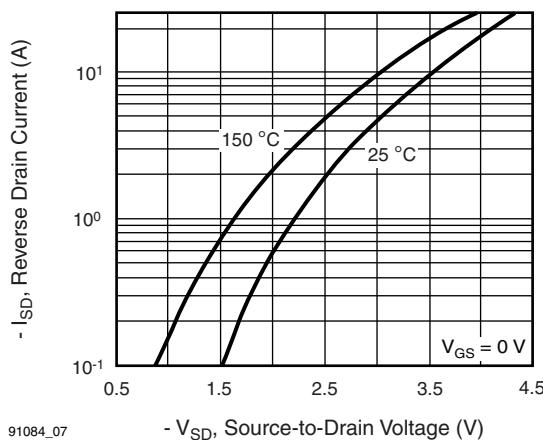
**SPECIFICATIONS** ( $T_J = 25$  °C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
<b>Static</b>								
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0$ V, $I_D = -250$ µA		-200	-	-	V	
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, $I_D = -1$ mA		-	-0.24	-	V/°C	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = -250$ µA		-2.0	-	-4.0	V	
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20$ V		-	-	$\pm 100$	nA	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -200$ V, $V_{GS} = 0$ V		-	-	-100	µA	
		$V_{DS} = -160$ V, $V_{GS} = 0$ V, $T_J = 125$ °C		-	-	-500		
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = -10$ V	$I_D = -3.9$ A <sup>b</sup>	-	-	0.80	Ω	
Forward Transconductance	$g_{fs}$	$V_{DS} = -50$ V, $I_D = -3.9$ A <sup>b</sup>		2.8	-	-	S	
<b>Dynamic</b>								
Input Capacitance	$C_{iss}$	$V_{GS} = 0$ V, $V_{DS} = -25$ V, $f = 1.0$ MHz, see fig. 5		-	700	-	pF	
Output Capacitance	$C_{oss}$			-	200	-		
Reverse Transfer Capacitance	$C_{rss}$			-	40	-		
Total Gate Charge	$Q_g$	$V_{GS} = -10$ V	$I_D = -6.5$ A, $V_{DS} = -160$ V, see fig. 6 and 13 <sup>b</sup>	-	-	29	nC	
Gate-Source Charge	$Q_{gs}$			-	-	5.4		
Gate-Drain Charge	$Q_{gd}$			-	-	15		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -100$ V, $I_D = -6.5$ A, $R_g = 12$ Ω, $R_D = 15$ Ω, see fig. 10 <sup>b</sup>		-	12	-	ns	
Rise Time	$t_r$		-	27	-			
Turn-Off Delay Time	$t_{d(off)}$		-	28	-			
Fall Time	$t_f$		-	24	-			
Internal Drain Inductance	$L_D$	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal Source Inductance	$L_S$			-	7.5	-		
Gate Input Resistance	$R_g$	$f = 1$ MHz, open drain		0.6	-	3.7	Ω	
<b>Drain-Source Body Diode Characteristics</b>								
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode		-	-	-6.5	A	
Pulsed Diode Forward Current <sup>a</sup>	$I_{SM}$			-	-	-26		
Body Diode Voltage	$V_{SD}$	$T_J = 25$ °C, $I_S = -6.5$ A, $V_{GS} = 0$ V <sup>b</sup>		-	-	-6.5	V	
Body Diode Reverse Recovery Time	$t_{rr}$	$T_J = 25$ °C, $I_F = -6.5$ A, $dI/dt = 100$ A/µs <sup>b</sup>		-	200	300	ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$			-	1.9	2.9	µC	
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )						

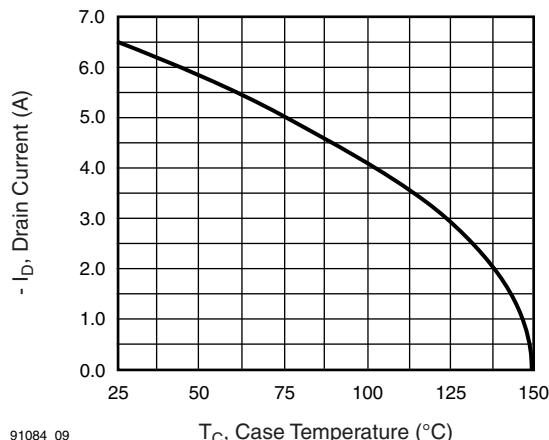
**Notes**

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- Pulse width  $\leq 300$  µs; duty cycle  $\leq 2$  %.

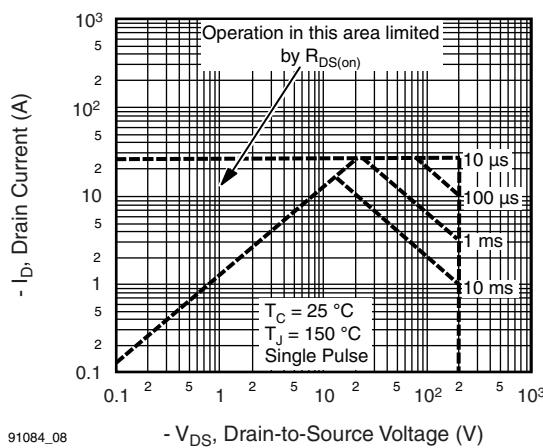
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Fig. 1 - Typical Output Characteristics,  $T_c = 25$  °C**

**Fig. 4 - Normalized On-Resistance vs. Temperature**

**Fig. 2 - Typical Output Characteristics,  $T_c = 150$  °C**

**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

**Fig. 3 - Typical Transfer Characteristics**

**Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage**



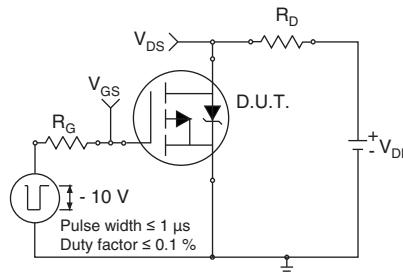
**Fig. 7 - Typical Source-Drain Diode Forward Voltage**



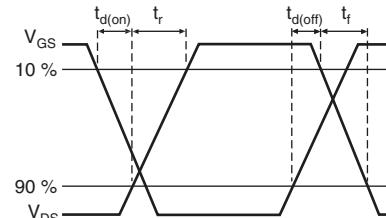
**Fig. 9 - Maximum Drain Current vs. Case Temperature**



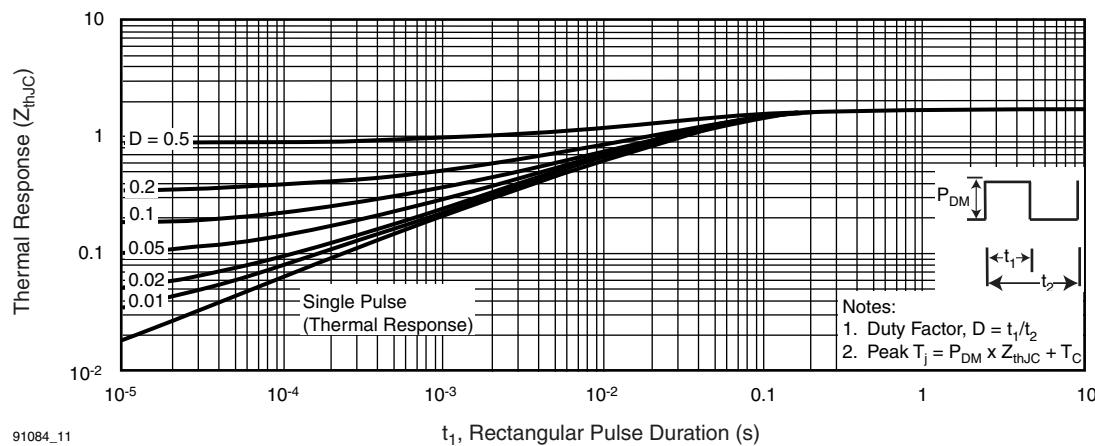
**Fig. 8 - Maximum Safe Operating Area**



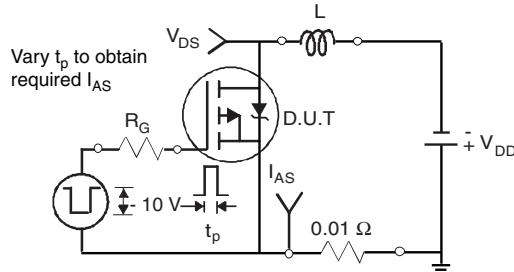
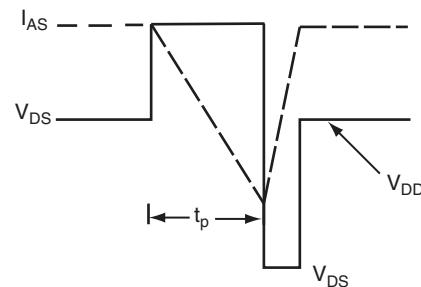
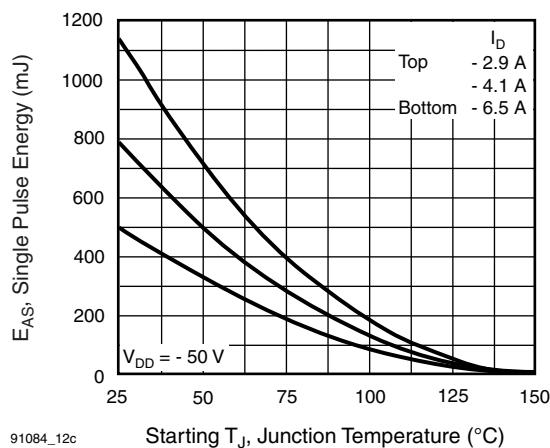
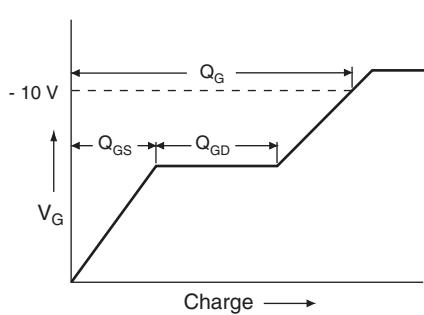
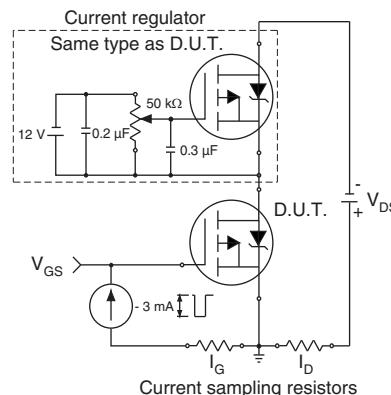
**Fig. 10a - Switching Time Test Circuit**

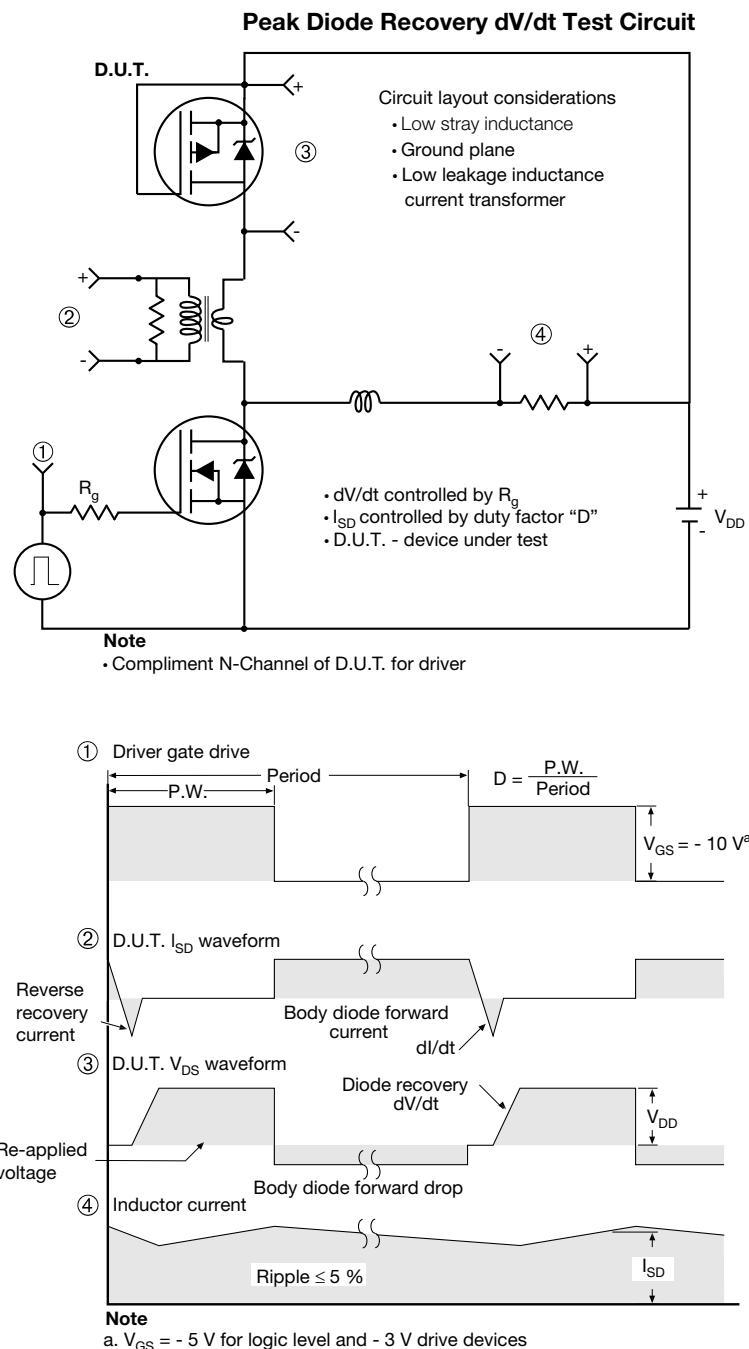


**Fig. 10b - Switching Time Waveforms**



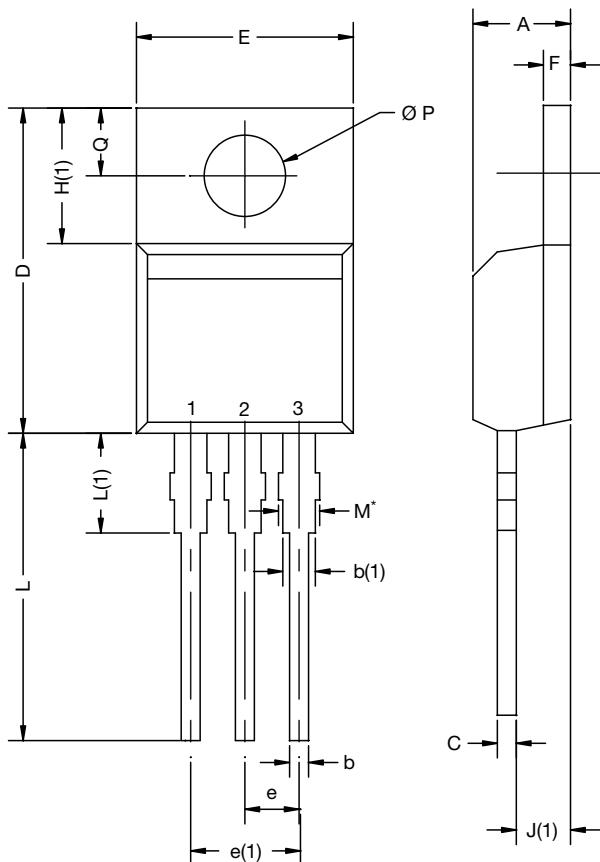
**Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**


**Fig. 12a - Unclamped Inductive Test Circuit**

**Fig. 12b - Unclamped Inductive Waveforms**

**Fig. 12c - Maximum Avalanche Energy vs. Drain Current**

**Fig. 13a - Basic Gate Charge Waveform**

**Fig. 13c - Gate Charge Test Circuit**


**Fig. 14 - For P-Channel**

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see [www.vishay.com/ppg?91084](http://www.vishay.com/ppg?91084).

### TO-220-1



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
c	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
e	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
Ø P	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

ECN: X15-0364-Rev. C, 14-Dec-15  
DWG: 6031

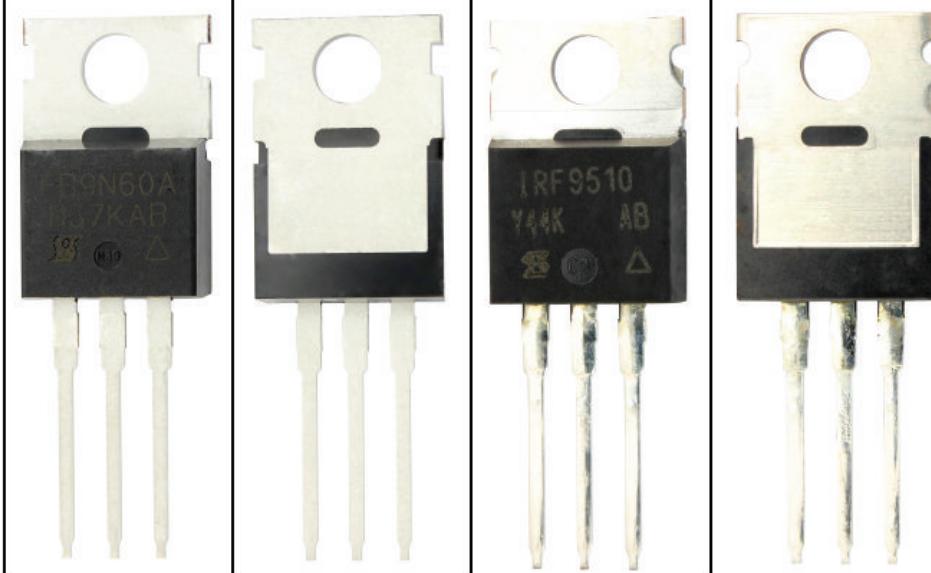
#### Note

- $M^* = 0.052$  inches to  $0.064$  inches (dimension including protrusion), heatsink hole for HVM

Package Picture

ASE

Xi'an



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